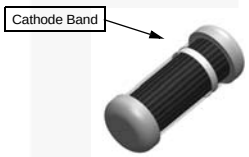
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March 2015

FDH300 / FDH300A / FDLL300A / FDH333 / FDLL333
High Conductance Low Leakage Diode



DO-35
Cathode is denoted with a black band



LL-34 (SOD-80)
THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

LL-34 COLOR BAND MARKING

DEVICE	1ST BAND
FDLL300A	WHITE
FDLL333	WHITE

-1st band denotes cathode terminal and has wider width

Ordering Information

Part Number	Top Mark	Package	Packing Method
FDH300TR	FDH300	DO-204AH (DO-35)	Tape and Reel
FDH300A	FDH300A	DO-204AH (DO-35)	Bulk
FDH300ATR	FDH300A	DO-204AH (DO-35)	Tape and Reel
FDH333	FDH333	DO-204AH (DO-35)	Bulk
FDH333TR	FDH333	DO-204AH (DO-35)	Tape and Reel
FDLL300A	WHITE	SOD-80 2L	Tape and Reel
FDLL333	WHITE	SOD-80 2L	Tape and Reel

Absolute Maximum Ratings[1], [2]

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter		Value	Unit
W_{IV}	Working Inverse Voltage		125	V
I_O	Average Rectified Forward Current		200	mA
I_F	DC Forward Current		500	mA
i_f	Recurrent Peak Forward Current		600	mA
I_{FSM}	Non-Repetitive Peak Forward Surge Current	Pulse Width = 1.0 s	1.0	A
		Pulse Width = 1.0 µs	4.0	
T_{STG}	Storage Temperature Range		-65 to +200	°C
T_J	Operating Junction Temperature		175	°C

Notes:

1. These ratings are based on a maximum junction temperature of 200°C.
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

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Thermal Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Max.	Unit
P_D	Total Device Dissipation	500	mW
	Derate Above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	300	°C/W

Electrical Characteristics

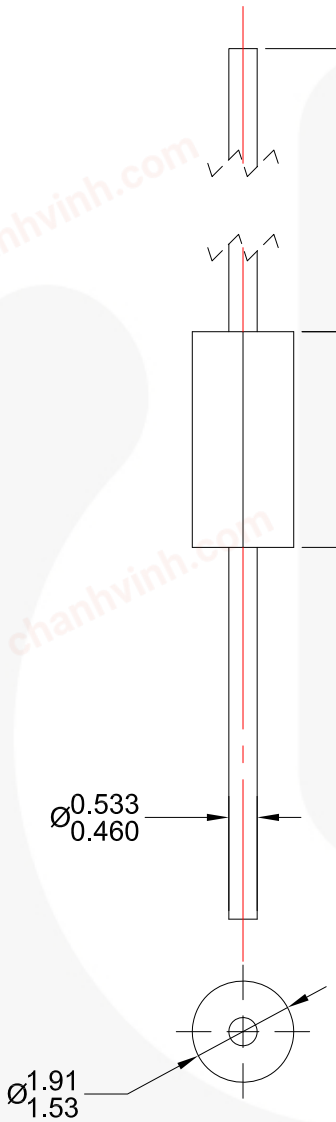
Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter		Conditions	Min.	Max.	Unit
V_R	Breakdown Voltage		I_R = 100 µA	150		V
V_F	Forward Voltage	FDH300 / FDH300A / FDLL300A	I_F = 1.0 mA		680	mV
		FDH300	I_F = 5.0 mA		750	mV
		FDH300A / FDLL300A	I_F = 5.0 mA		760	mV
		FDH300 / FDH300A / FDLL300A	I_F = 10 mA		800	mV
		FDH300	I_F = 50 mA		880	mV
		FDH300A / FDLL300A	I_F = 50 mA		890	mV
		FDH300 / FDH300A / FDLL300A	I_F = 100 mA		920	mV
		FDH300 / FDH300A / FDLL300A	I_F = 200 mA		1.0	V
		FDH333 / FDLL333	I_F = 50 mA	800	890	mV
			I_F = 100 mA	830	940	mV
			I_F = 150 mA	860	970	mV
			I_F = 200 mA	0.87	1.05	V
			I_F = 250 mA	0.88	1.08	V
			I_F = 300 mA	0.90	1.15	V
I_R	Reverse Current	FDH300 / FDH300A / FDLL300A	V_R = 125 V		1.0	nA
			V_R = 125 V, T_A = 150°C		3.0	µA
		FDH333 / FDLL333	V_R = 125 V		3.0	nA
			V_R = 125 V, T_A = 100°C		500	nA
C_O	Diode Capacitance		V_R = 0, f = 1.0 MHz		6.0	pF

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Physical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED

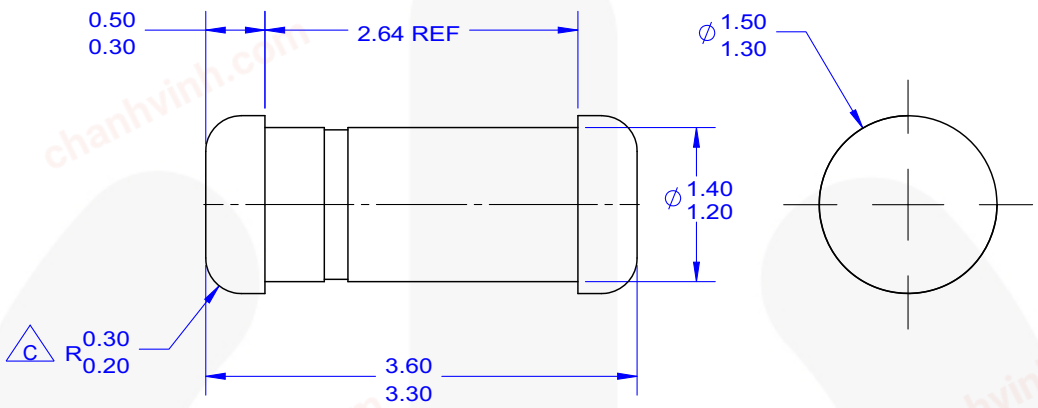
A) PACKAGE STANDARD REFERENCE:
JEDEC DO-204, VARIATION AH.
B) HERMETICALLY SEALED GLASS PACKAGE.
C) PACKAGE WEIGHT IS 0.137 GRAM.
D) ALL DIMENSIONS ARE IN MILLIMETERS.
E) DRAWING FILE NAME:DO35AREV02

Figure 1. AXIAL LEADED, GLASS, JEDEC DO204, VARIATION AH (DO-35)

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Physical Dimensions (Continued)



NOTES: UNLESS OTHERWISE SPECIFIED

A) PACKAGE STANDARD REFERENCE: JEDEC DO-213, VARIATION AC.

B) ALL DIMENSIONS ARE IN MILLIMETERS.

C CORNER RADIUS IS OPTIONAL.

D) DRAWING FILE NAME: SOD80AREV02

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Figure 2. 2-TERMINAL, SOD-80, JEDEC DO-213AC, MINI-MELF

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